Characteristics EMIF03-SIM02F2

1 Characteristics

Table 1. Absolute maximum ratings ($T_{amb} = 25$ °C)

Symbol	Parameter and test conditions	Value	Unit
	Internal pins (A3, B3, C3):		
V _{PP}	ESD discharge IEC61000-4-2, air discharge	2	
	ESD discharge IEC61000-4-2, contact discharge	2	kV
	External pins (A2, B1, C2, C1):		KV
	ESD discharge IEC61000-4-2, air discharge	15	
	ESD discharge IEC61000-4-2, contact discharge	8	
Tj	Maximum junction temperature	125	°C
T _{op}	Operating temperature range	-40 to +85	°C
T _{stg}	Storage temperature range	-55 to 150	°C

Table 2. Electrical characteristics ($T_{amb} = 25 \, ^{\circ}C$)

Symbol	Parameters					
V _{BR}	Breakdown voltage	 				
I _{RM}	Leakage current @ V _{RM}			IF		
V _{RM}	Stand-off voltage					
V _{CL}	Clamping voltage	V	V _{BR} V _{RM}	V _F		
R _d	Dynamic impedance	VCL	VBR VRM	I _{RM}	→ V	
I _{PP}	Peak pulse current			in .		
R _{I/O}	Series resistance between Input & Output			IPP		
C _{line}	Input capacitance per line			ı		
Symbol	Test conditions		Min	Тур	Max	Unit
V _{BR}	I _R = 1 mA		6		20	V
I _{RM}	V _{RM} = 3V				0.2	μΑ
R _d				1.5		Ω
R _{1,} R ₃	Tolerance ± 20%			100		Ω
R ₂	Tolerance ± 20%		47		Ω	
C _{line}	@ 0V				20	pF

EMIF03-SIM02F2 Characteristics

Figure 3. S21 (dB) attenuation measurement Figure 4. S21 (dB) attenuation measurement (A2-A3 line) (B1-B3 line)

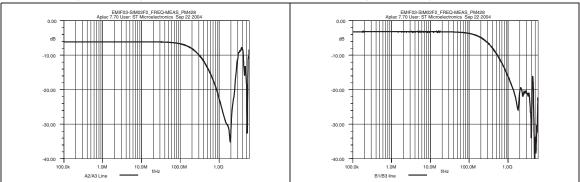


Figure 5. S21 (dB) attenuation measurement Figure 6. Analog crosstalk measurements (C1-C3 line)

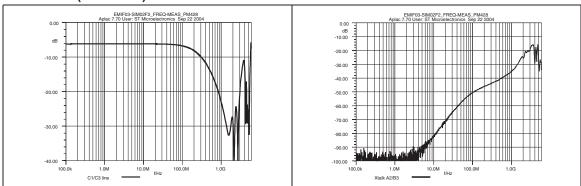
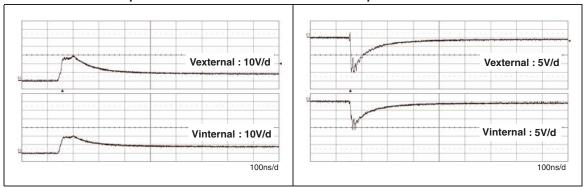


Figure 7. Voltages when IEC61000-4-2 (+15 kV air discharge) applied to external pin

Figure 8. Voltages when IEC61000-4-2 (-15 kV air discharge) applied to external pin



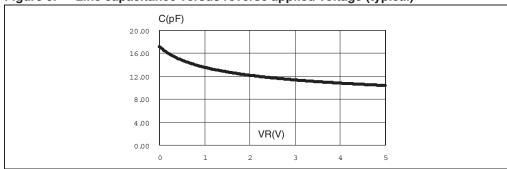


Figure 9. Line capacitance versus reverse applied voltage (typical)

2 Application information



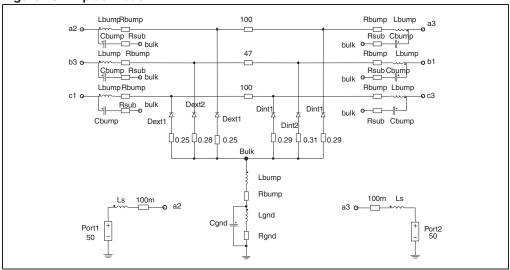
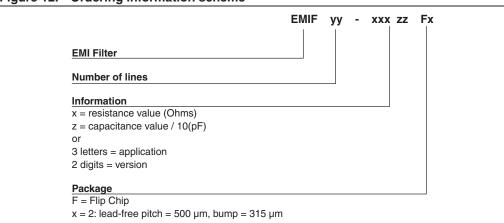


Figure 11. Aplac parameters

<u> </u>	P P				
	Ls 950pH				
	Rs 150m	Model Dint1	Model Dext1	Model Dint2	Model Dext2
	Cext1 15pF	BV=15	BV=15	BV=15	BV=15
	Cint1 4.5pF	CJO=Cint1	CJO=Cext1	CJO=Cint2	CJO=Cext2
	Cext2 14pF	IBV=1u	IBV=1u	IBV=1u	IBV=1u
	Cint2 4pF	IKF=1000	IKF=1000	IKF=1000	IKF=1000
	Rbump 20m	IS=10f	IS=10f	IS=10f	IS=10f
	Lbump 50pH	ISR=100p	ISR=100p	ISR=100p	ISR=100p
	Cbump 0.15pF	N=1	N=1	N=1	N=1
	Rgnd 500m	M=0.3333	M=0.3333	M=0.3333	M=0.3333
	Lgnd 50pH	RS=0.001m	RS=0.001m	RS=0.001m	RS=0.001m
	Cgnd 0.15pF	VJ=0.6	VJ=0.6	VJ=0.6	VJ=0.6
	Rsub 100m	TT=50n	TT=50n	TT=50n	TT=50n

3 Ordering information scheme

Figure 12. Ordering information scheme



4 Package information

In order to meet environmental requirements, ST offers these devices in ECOPACK[®] packages. These packages have a lead-free second level interconnect. The category of second level interconnect is marked on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at www.st.com.

Figure 13. Package dimensions

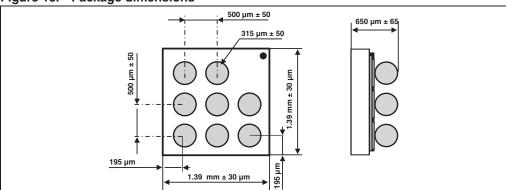


Figure 14. Footprint

Figure 15. Marking

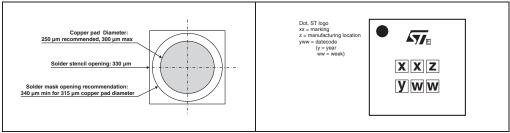
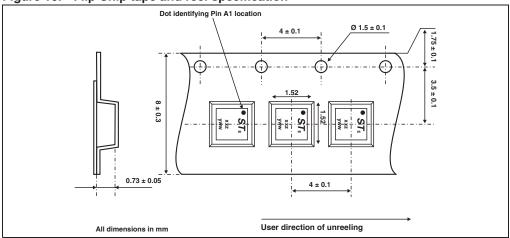


Figure 16. Flip Chip tape and reel specification



Note:

More information isavailable in the application notes:

AN1235:"Flip Chip: Package description and recommendations for use"

AN1751: "EMI filters: Recommendations and measurements"

5 Ordering information

Table 3. Ordering information

Order code	Marking	Package	Weight	Base qty	Delivery mode
EMIF03-SIM02F2	GJ	Flip Chip	2.65 mg	5000	Tape and reel 7"

EMIF03-SIM02F2 Revision history

6 Revision history

Table 4. Document revision history

Date	Revision	Changes
08-Oct-2004	1	First issue.
20-Oct-2004	2	Minor layout update.
25-Mar-2005	3	Figure 1 on page 1: pin configuration definitions changed from RST out, CLK out and Data out to RST ext, CLK ext and Data ext.
13-Jun-2005	4	Titles in Figures 7 and 8 changed - No technical data changed
12-Sep-2005	5	"out" changed to "ext" in Figure 2.
24-Apr-2008	6	Updated ECOPACK statement. Updated <i>Figure 12</i> , <i>Figure 13</i> , <i>Figure 14</i> , <i>Figure 15</i> and <i>Figure 16</i> . Reformatted to current standards.

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